

Features

- Low $R_{DS(on)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity

Product Summary

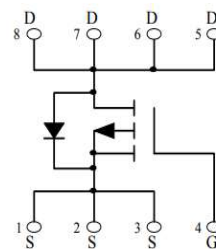
V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
-100V	85mΩ@-10V	-30A
	102mΩ@-4.5V	

Application

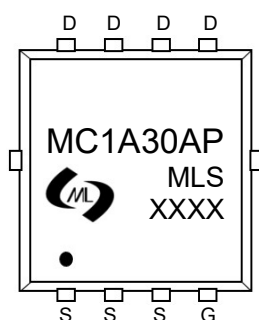
- Power management
- Portable equipment



PDFN5X6-8L view



Schematic diagram



Marking and pin assignment

MC1A30AP: Device code
XXXX : Code



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	-100	V
V_{GS}	Gate-Source Voltage	±20	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C -30	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	Tc=25°C -120	A
I_D	Continuous Drain Current	Tc=25°C -30	A
P_D	Maximum Power Dissipation	Tc=25°C 78	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	83.3	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MC1A30AP	PDFN5X6-8L	MC1A30AP	5,000	10,000	70,000	13"reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV(BR)DSS	Drain-Source Breakdown Voltage	VGS=0V, ID=-250μA	-100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V, VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=-250μA	-1.0	--	-2.5	V
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-20A	--	66	85	mΩ
		VGS=-4.5V, ID=-10A	--	75	102	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
Ciss	Input Capacitance	VDS=-15V, VGS=0V, f=1MHz	--	2820	--	pF
Coss	Output Capacitance		--	840	--	pF
CRSS	Reverse Transfer Capacitance		--	670	--	pF
Switching Characteristics						
Qg	Total Gate Charge	VDS=-50V, ID=-10A, VGS=-10V	--	5.9	--	nC
Qgs	Gate Source Charge		--	1.2	--	nC
Qgd	Gate Drain Charge		--	1.2	--	nC
t d(on)	Turn-on Delay Time	VDS=-50V, ID=-10A, VGS=-10V, RG=3Ω	--	6	--	nS
t r	Turn-on Rise Time		--	2.4	--	nS
t d(off)	Turn-Off Delay Time		--	19	--	nS
t f	Turn-Off Fall Time		--	2.6	--	nS
Source- Drain Diode Characteristics						
VSD	Forward on voltage	TJ=25°C, IS=-20A	--	-0.8	-1.2	V

Typical Operating Characteristics

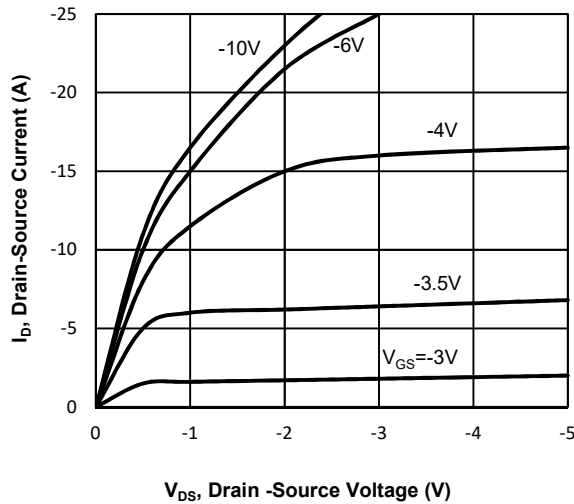


Fig1. Typical Output Characteristics

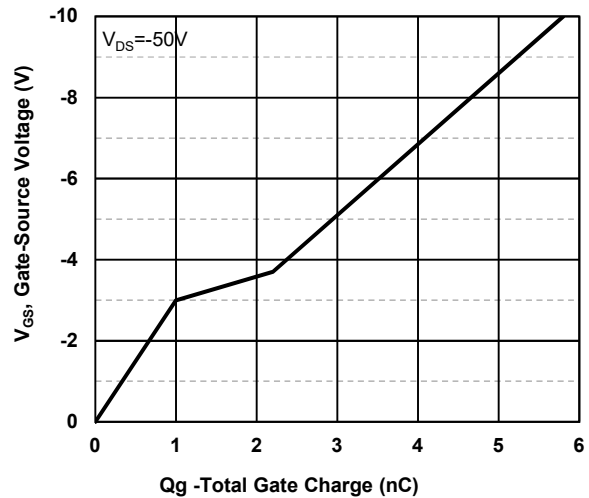


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

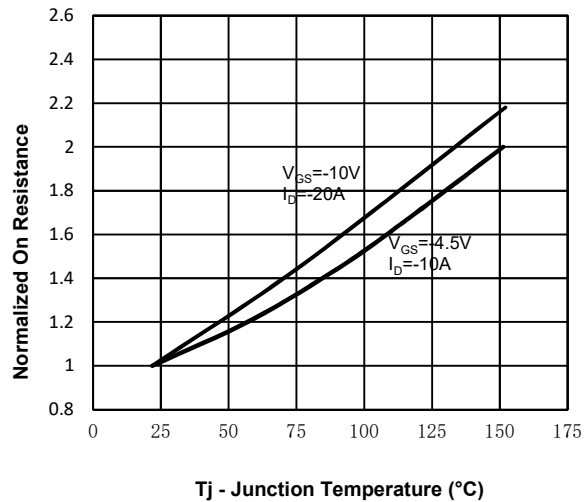


Fig3. Normalized On-Resistance Vs. Temperature

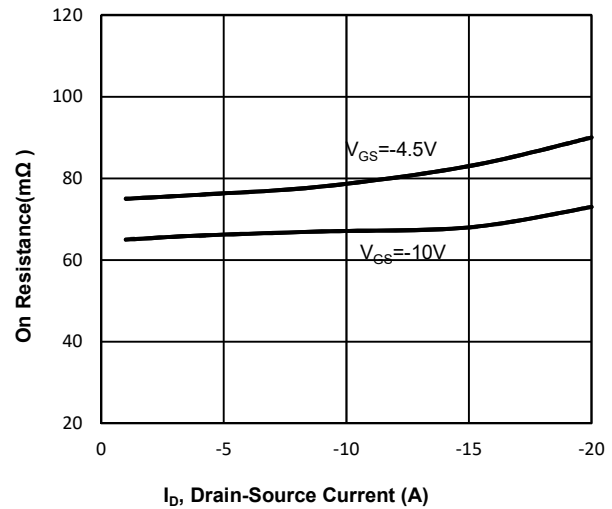


Fig4. On-Resistance Vs. Drain-Source Current

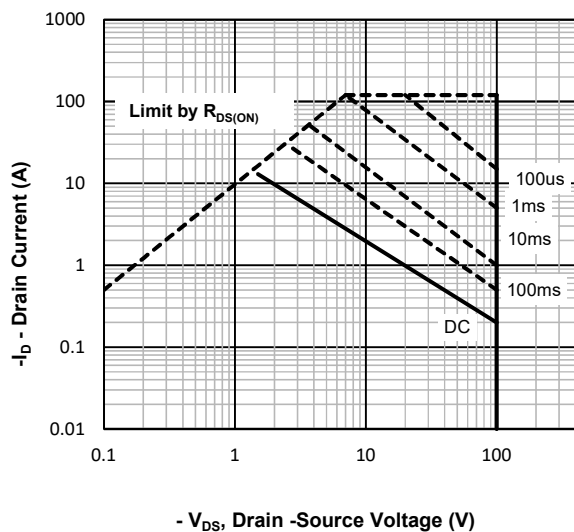


Fig5. Maximum Safe Operating Area

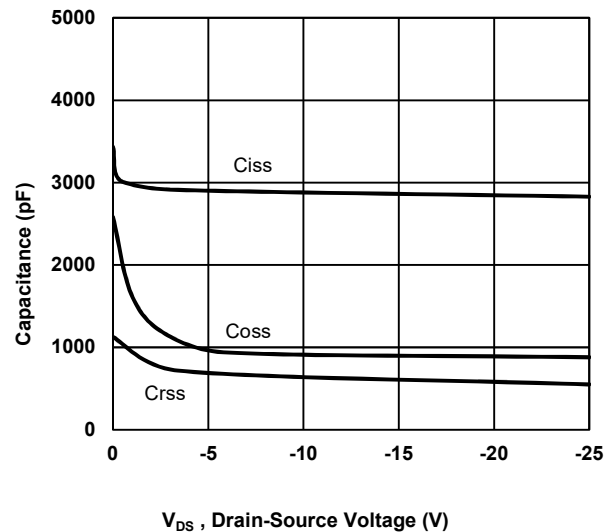
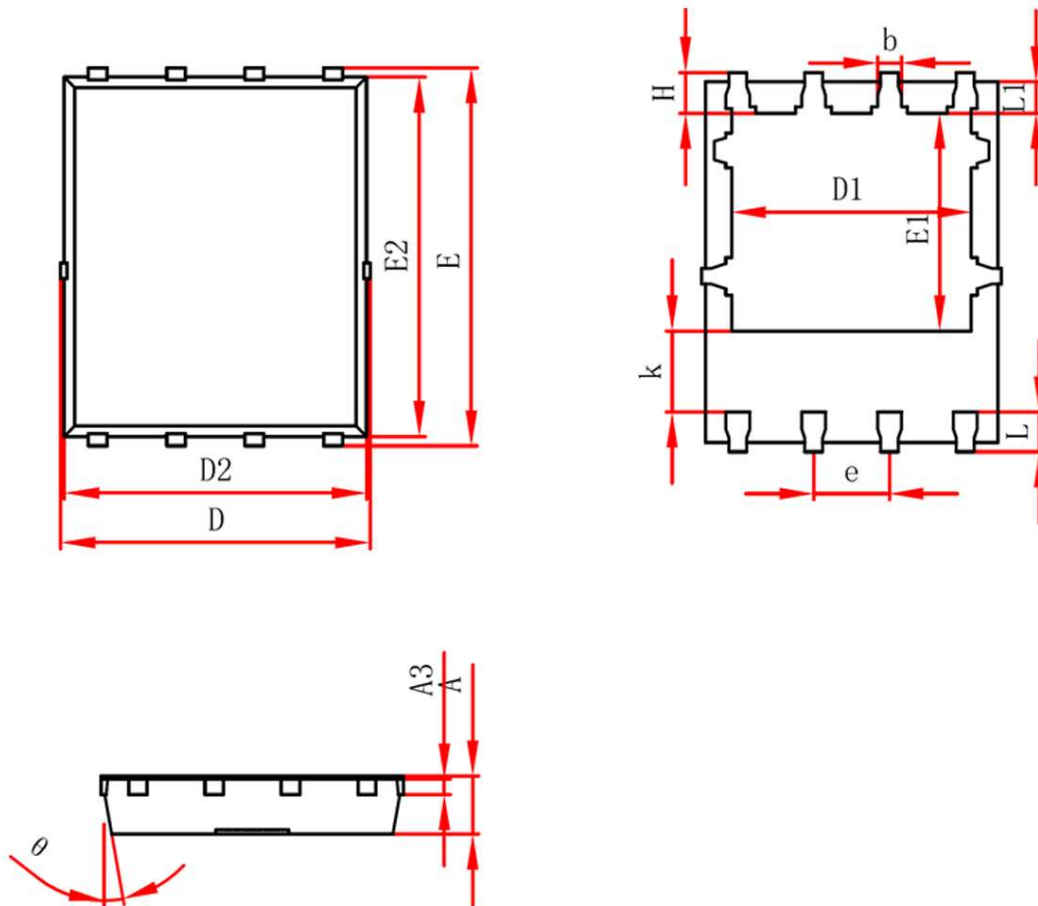


Fig6 Typical Capacitance Vs. Drain-Source Voltage

PDFN5X6-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.950	1.050	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.950	5.050	0.196	0.200
E	5.950	6.050	0.235	0.239
D1	4.026	4.126	0.159	0.163
E1	3.510	3.610	0.139	0.143
D2	4.850	4.950	0.192	0.196
E2	5.700	5.800	0.225	0.229
k	1.190	1.390	0.047	0.055
b	0.300	0.400	0.012	0.016
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°